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# FDG332PZ

## P-Channel PowerTrench® MOSFET

-20V, -2.6A, 97mΩ

### Features

- Max  $r_{DS(on)}$  = 95mΩ at  $V_{GS} = -4.5V$ ,  $I_D = -2.6A$
- Max  $r_{DS(on)}$  = 115mΩ at  $V_{GS} = -2.5V$ ,  $I_D = -2.2A$
- Max  $r_{DS(on)}$  = 160mΩ at  $V_{GS} = -1.8V$ ,  $I_D = -1.9A$
- Max  $r_{DS(on)}$  = 330mΩ at  $V_{GS} = -1.5V$ ,  $I_D = -1.0A$
- Very low level gate drive requirements allowing operation in 1.5V circuits
- Very small package outline SC70-6
- RoHS Compliant

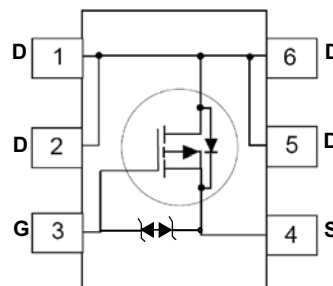
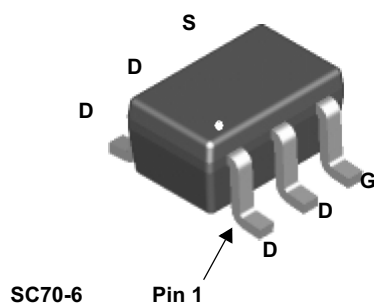


### General Description

This P-Channel MOSFET uses Fairchild's advanced low voltage PowerTrench® process. It has been optimized for battery power management applications.

### Applications

- Battery management
- Load switch



### MOSFET Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain to Source Voltage	-20	V
$V_{GS}$	Gate to Source Voltage	$\pm 8$	V
$I_D$	Drain Current -Continuous	-2.6	A
	-Pulsed	-9	
$P_D$	Power Dissipation (Note 1a)	0.75	W
	Power Dissipation (Note 1b)	0.48	
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

### Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient Single operation (Note 1a)	170	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient Single operation (Note 1b)	260	

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.2P	FDG332PZ	SC70-6	7"	8 mm	3000 units

**Electrical Characteristics**  $T_J = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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**Off Characteristics**

$BV_{DSS}$	Drain to Source Breakdown Voltage	$I_D = -250\mu\text{A}$ , $V_{GS} = 0\text{V}$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250\mu\text{A}$ , referenced to $25^\circ\text{C}$		-13		mV/ $^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -16\text{V}$ , $V_{GS} = 0\text{V}$			-1	$\mu\text{A}$
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS} = \pm 8\text{V}$ , $V_{DS} = 0\text{V}$			$\pm 10$	$\mu\text{A}$

**On Characteristics**

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = -250\mu\text{A}$	-0.4	-0.7	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250\mu\text{A}$ , referenced to $25^\circ\text{C}$		2.5		mV/ $^\circ\text{C}$
$r_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = -4.5\text{V}$ , $I_D = -2.6\text{A}$		73	95	m $\Omega$
		$V_{GS} = -2.5\text{V}$ , $I_D = -2.2\text{A}$		90	115	
		$V_{GS} = -1.8\text{V}$ , $I_D = -1.9\text{A}$		117	160	
		$V_{GS} = -1.5\text{V}$ , $I_D = -1.0\text{A}$		147	330	
		$V_{GS} = -4.5\text{V}$ , $I_D = -2.6\text{A}$ , $T_J = 125^\circ\text{C}$		100	133	
$g_{FS}$	Forward Transconductance	$V_{DD} = -5\text{V}$ , $I_D = -2.6\text{A}$		9		S

**Dynamic Characteristics**

$C_{iss}$	Input Capacitance	$V_{DS} = -10\text{V}$ , $V_{GS} = 0\text{V}$ , $f = 1\text{MHz}$		420	560	pF
$C_{oss}$	Output Capacitance			85	115	pF
$C_{rss}$	Reverse Transfer Capacitance			75	115	pF

**Switching Characteristics**

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = -10\text{V}$ , $I_D = -2.6\text{A}$ , $V_{GS} = -4.5\text{V}$ , $R_{GEN} = 6\Omega$		5.2	10	ns
$t_r$	Rise Time			4.8	10	ns
$t_{d(off)}$	Turn-Off Delay Time			59	95	ns
$t_f$	Fall Time			28	45	ns
$Q_g$	Total Gate Charge	$V_{GS} = -4.5\text{V}$ , $V_{DD} = -10\text{V}$ , $I_D = -2.6\text{A}$		7.6	10.8	nC
$Q_{gs}$	Gate to Source Charge			0.9		nC
$Q_{gd}$	Gate to Drain "Miller" Charge			1.9		nC

**Drain-Source Diode Characteristics and Maximum Ratings**

I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				-0.6	A
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = -0.6A (Note 2)		-0.7	-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 2.6A, di/dt = 100A/μs		28	45	ns
Q <sub>rr</sub>	Reverse Recovery Charge			8	13	nC

**Notes:**

1.  $R_{\theta JA}$  is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



a. 170°C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.



b. 260°C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 $\mu\text{s}$ , Duty cycle < 2.0%.

# Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

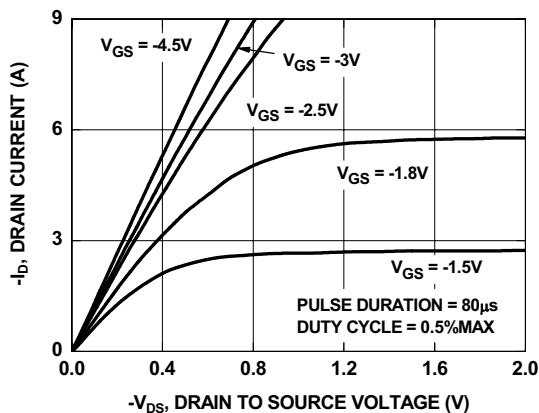


Figure 1. On-Region Characteristics

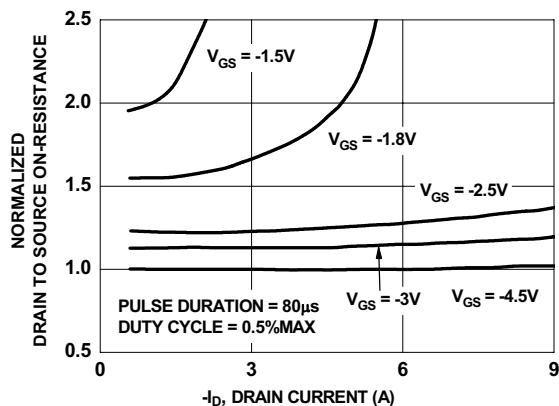


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

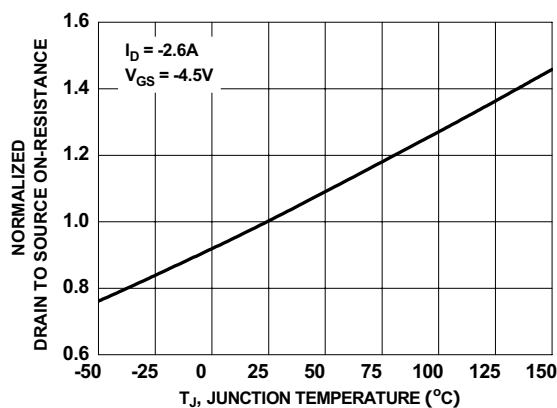


Figure 3. Normalized On-Resistance vs Junction Temperature

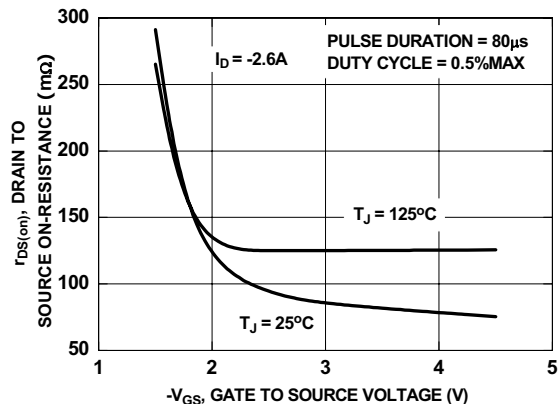


Figure 4. On-Resistance vs Gate to Source Voltage

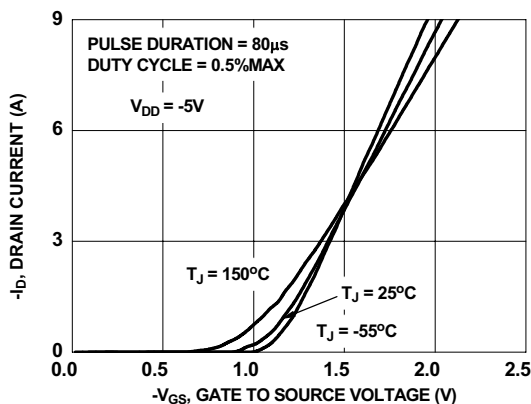


Figure 5. Transfer Characteristics

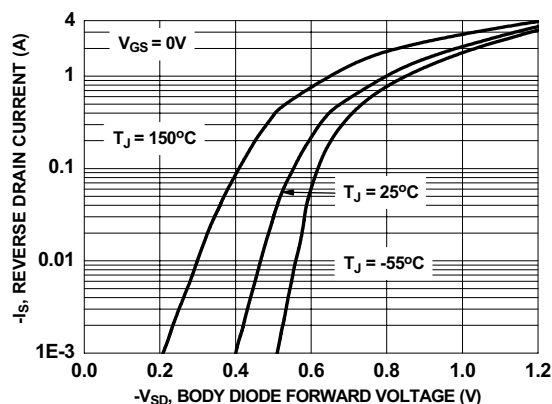


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

# Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

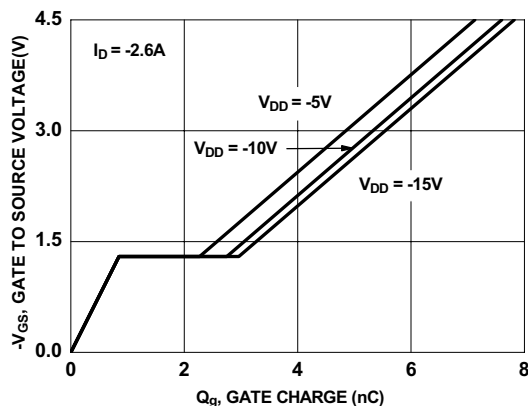


Figure 7. Gate Charge Characteristics

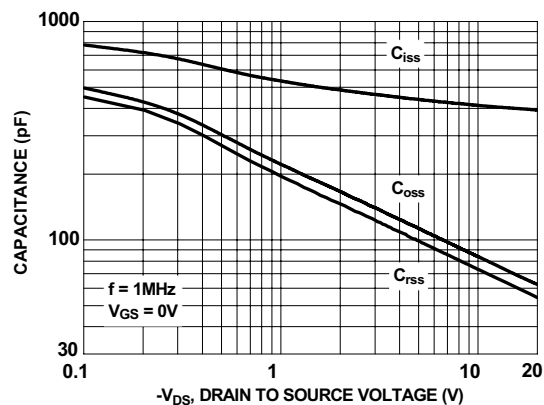


Figure 8. Capacitance vs Drain to Source Voltage

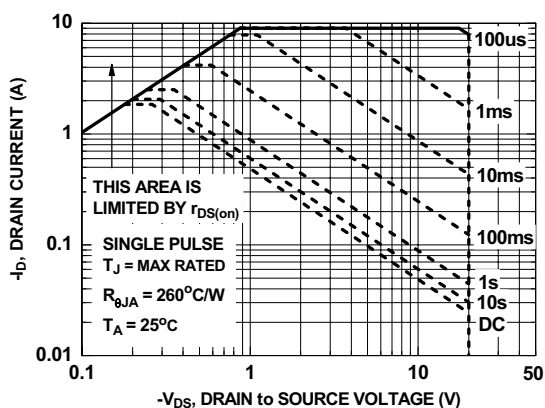


Figure 9. Forward Bias Safe Operating Area

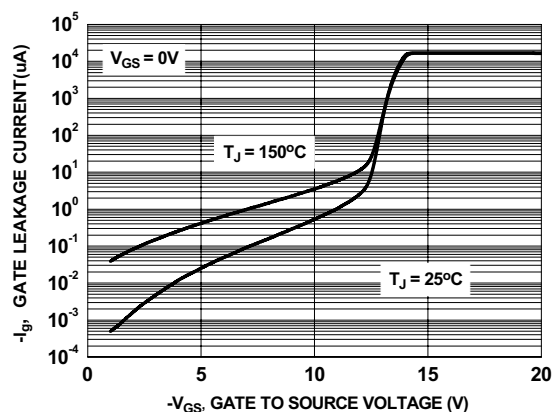


Figure 10. Gate Leakage Current vs Gate to Source Voltage

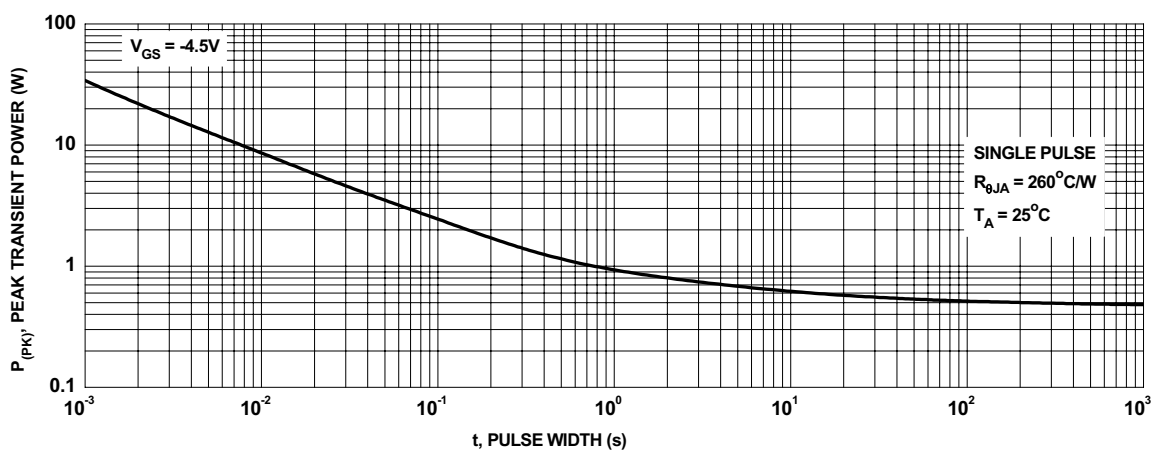


Figure 11. Transient Thermal Response Curve

# Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

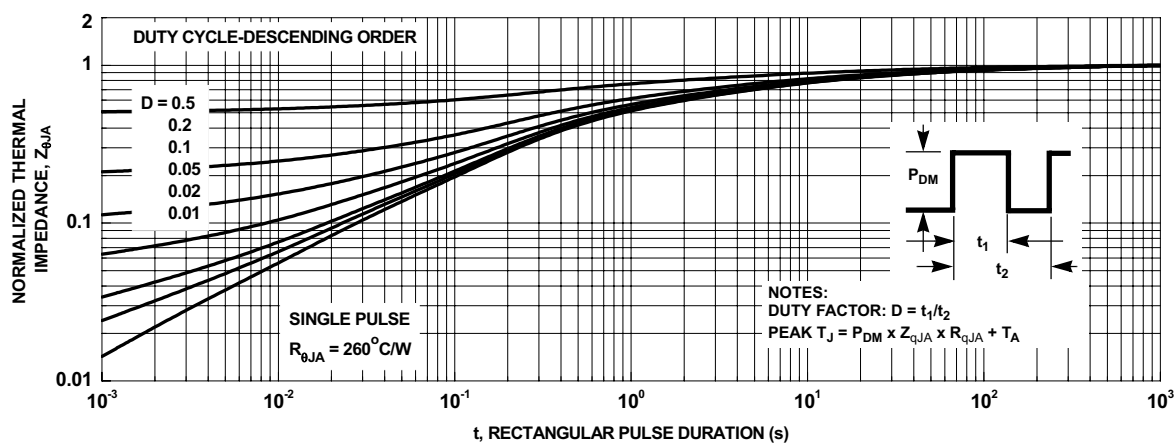


Figure 12. Transient Thermal Response Curve


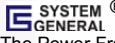



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